

# NNCD5.6J to NNCD36J

# 2-PIN ULTRA SUPER MINI MOLD (FLAT TYPE)

#### **DESCRIPTION**

These products are a diode developed for ESD (Electrostatic Discharge) absorption. Based on the IEC-61000-4-2 test on electromagnetic interference (EMI), the diode assures an endurance of no less than 30 kV, thus making itself most suitable for external interface circuit protection.

These products are can cope with more high density assembling.

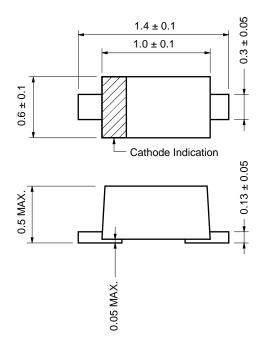
#### **FEATURES**

- Base on the electrostatic discharge immunity test (IEC 61000-4-2), the product assures the minimum endurance of 30 kV.
- Mounted in the ultra super mini mold (flat) package, the product can achiever high density and automatic packaging.

## **APPLICATIONS**

- External interface circuit ESD absorption.
- · Circuits for waveform clipper, surge absorber

# **PACKAGE DRAWING (Unit: mm)**



### MAXIMUM RATINGS (TA = 25°C)

| Item                 | Symbol           | Rating                      | Unit | Remark |
|----------------------|------------------|-----------------------------|------|--------|
| Power Dissipation    | Р                | 150                         | mW   | Total  |
| Surge Reverse Power  | Prsm             | 85 (t = 10 $\mu$ s 1 pulse) | W    |        |
| Junction Temperature | Tj               | 150                         | °C   |        |
| Storage Temperature  | T <sub>stg</sub> | –55 to +150                 | °C   |        |

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# **ELECTRICAL CHARACTERISTICS (TA = 25°C)**

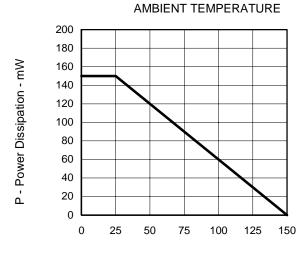
|   | TYPE No. | Breakdown Voltage Note1  VBR (V) |      |         | Capacitance<br>Ct (pF) |                      | Reverse Leakage<br>I <sub>R</sub> (μA) |                    | ESD Voltage <sup>Note2</sup><br>(kV) |            |
|---|----------|----------------------------------|------|---------|------------------------|----------------------|--|--------------------|--------------------------------------|------------|
|   |          | MIN.                             | MAX. | I⊤ (mA) | TYP.                   | Condition            | MAX.                                   | V <sub>R</sub> (V) | MAX.                                 | Iτ (mA)    |
| * | NNCD5.6J | 5.3                              | 6.3  | 5       | 110                    | V <sub>R</sub> = 0 V | 5                                      | 2.5                | 30                                   | C = 150 pF |
|   | NNCD6.8J | 6.2                              | 7.1  | 5       | 90                     | f = 1 MHz            | 2                                      | 3.5                | 30                                   | R = 330 Ω  |
|   | NNCD8.2J | 7.7                              | 8.7  | 5       | 70                     |                      | 2                                      | 5.0                | 30                                   | Contact    |
| * | NNCD10J  | 9.0                              | 11.0 | 5       | 55                     |                      | 2                                      | 7.0                | 30                                   | discharge  |
|   | NNCD16J  | 15.0                             | 17.0 | 5       | 30                     |                      | 2                                      | 12.0               | 30                                   |            |
|   | NNCD36J  | 34.0                             | 38.0 | 2       | 15                     |                      | 2                                      | 27.0               | 12                                   |            |

Notes 1. Tested with pulse (40 ms)

**2**. Based upon with IEC 61000-4-2

# TYPICAL CHARACTERISTICS (TA = 25°C)

Figure 1. POWER DISSIPATION vs.



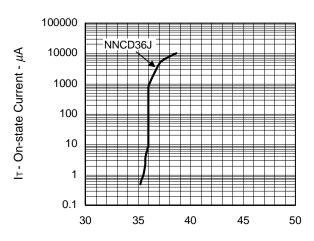
TA - Ambient Temperature - °C

Figure 2. It - VBR CHARACTERISTICS

100000 NNCD5.6J NNCD16J NNCD16J 1000 100 100 100 100 NNCD6.8J NNCD10J 0.1 0 5 10 15 20

V<sub>BR</sub> - Breakdown Voltage - V

Figure 3. It - VBR CHARACTERISTICS



V<sub>BR</sub> - Breakdown Voltage - V

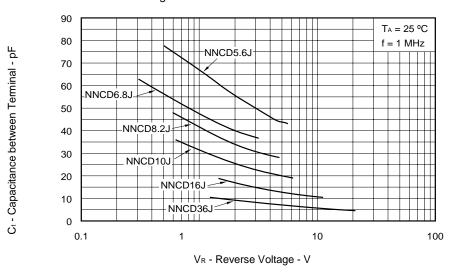
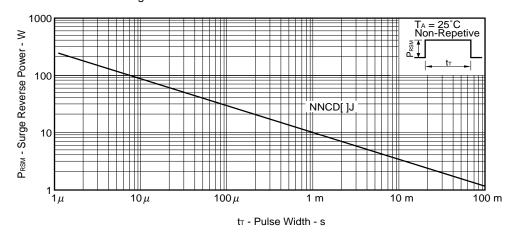
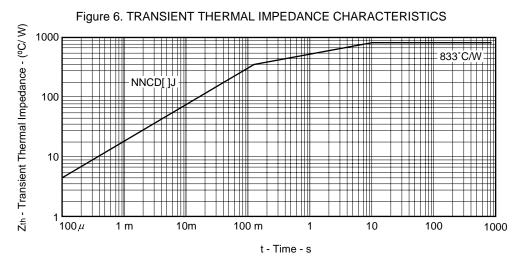


Figure 4. Ct - VR CHARACTERISTICS







**Remark** When using ceramic board of 10 x 7.5 x 0.75 mm (Cu film 11 x 2 x 0.035 mm)

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